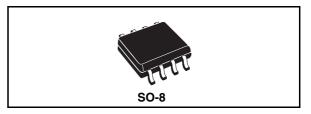


High side driver

Features

Туре	R _{DS(on)}	I _{out}	V _{CC}	
VN751S	60 m $Ω$	2.5 A	36 V	

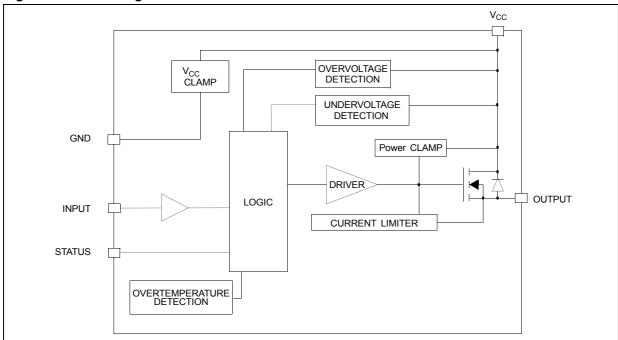
- CMOS compatible input
- Thermal shutdown
- Shorted load protection
- Undervoltage and overvoltage shutdown
- Protection against loss of ground
- Very low stand-by current
- Compliance to 61000-4-4 IEC test up to 4 kV



Description

The VN751S is a monolithic device designed in STMicroelectronics VIPower M0-3 technology, intended for driving any kind of load with one side connected to ground. Active V_{CC} pin voltage clamp protects the device against low energy spikes. Active current limitation combined with thermal shutdown and automatic restart protect the device against overload. Device automatically turns off in case of ground pin disconnection. This device is especially suitable for industrial applications in conformity with IEC 61131-2 programmable controllers international standard.

Figure 1. Block diagram



Contents VN751S

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VN751S Maximum ratings

1 Maximum ratings

Table 1. Absolute maximum rating

Symbol	Parameter	Value	Unit
V _{CC}	DC supply voltage (overvoltage protected)	45	V
- V _{CC}	Reverse DC supply voltage	-0.3	V
- I _{GND}	DC reverse ground pin current	-200	mA
I _{OUT}	DC output current	Internally limited	Α
- I _{OUT}	Reverse DC output current	-5	Α
I _{IN}	DC input current	+/- 10	mA
I _{STAT}	DC status current	+/- 10	mA
V _{ESD}	Electrostatic discharge (R = 1.5 kΩ; C = 100 pF)	5000	V
P _{tot}	Power dissipation T _C = 25 °C	Internally limited	W
T _J	Junction operating temperature	Internally limited	°C
T _c	Case operating temperature	- 40 to 150	°C
T _{stg}	Storage temperature	- 55 to 150	°C
E _{AS}	Single-pulse avalanche energy	0.8	J

Table 2. Thermal data

Symbol	Parameter	Value	Unit	
B	R _{thJA} Thermal resistance junction-ambient		93 ⁽¹⁾	°C/W
' 'thJA			82 ⁽²⁾	
R _{thJC}	Thermal resistance junction-case	Max	15	°C/W

^{1.} When mounted on a standard single-sided FR-4 board with 0.5 cm 2 of Cu (at least 35 μ m) thick connected to all V_{CC} pins. Horizontal mounting and no artificial air flow.

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^{2.} When mounted on a standard single-sided FR-4 board with 2 cm² of Cu (at least $35\mu m$) thick connected to all V_{CC} pins. Horizontal mounting and no artificial air flow.

Pin connections VN751S

2 Pin connections

Figure 2. Connection diagram (top view)

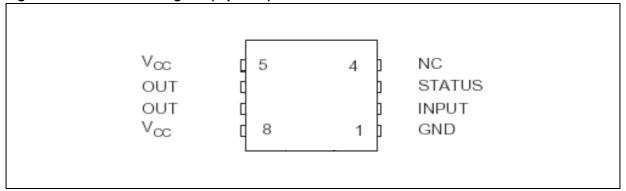
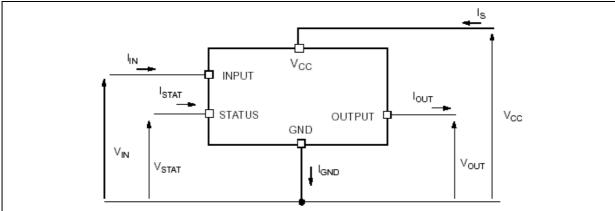


Figure 3. Current and voltage conventions



3 Electrical characteristics

8 V < V_{CC} < 36 V; -40 °C < T_J < 125 °C, unless otherwise specified

Table 3. Power

Symbol	Parameter	Test conditions	Min	Тур	Max	Unit
V _{CC}	Operating supply voltage		5.5		36	V
V _{USD}	Undervoltage shut-down		3	4	5.5	V
V _{OV}	Overvoltage shut-down		36			V
R _{ON}	On state resistance	I _{OUT} = 2 A; T _J = 25 °C I _{OUT} = 2 A		60	180	mΩ
I _S	Supply current	Off state; $V_{CC} = 24 \text{ V}$; $T_{CASE} = 25 \text{ °C}$ On state; $V_{CC} = 24 \text{ V}$ On state; $V_{CC} = 24 \text{ V}$; $T_{CASE} = 100 \text{ °C}$		10 1.5	20	μA mA mA
I _{L(off)}	Off state output current	V _{IN} = V _{OUT} = 0 V	0		10	μА

Table 4. Switching ($V_{CC} = 24 \text{ V}$)

Symbol	Parameter	Test conditions	Min	Тур	Max	Unit
t _{d(on)}	Turn-on delay time	R_L = 12 Ω from V_{IN} rising edge to V_{OUT} = 2.4 V		12		μS
t _{d(off)}	Turn-off delay time	R_L = 12 Ω from V_{IN} falling edge to V_{OUT} = 21.6 V		35		μS
dV _{OUT} /dt _(on)	Turn -on voltage slope	$R_L = 12\Omega$ from $V_{OUT} = 2.4$ V to $V_{OUT} = 19.2$ V		0.80		V/µs
$dV_{OUT}/dt_{(off)}$	Turn -off voltage slope	R_L = 12 Ω from V_{OUT} = 21.6 V to V_{OUT} = 2.4 V		0.30		V/μs

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Electrical characteristics VN751S

Table 5. Input pin

Symbol	Parameter	Test conditions	Min	Тур	Max	Unit
V _{IL}	Input low level				1.25	V
I _{IL}	Low level input current	V _{IN =} 1.25 V	1			μА
V _{IH}	Input high level		3.25			٧
I _{IH}	High level input current	V _{IN =} 3.25 V			10	μА
V _{hyst}	Input hysteresis voltage		0.5			٧
I _{IN}	Input current	$V_{IN} = V_{CC} = 5 \text{ V}$			10	μΑ
V _{ICL}	Input clamp voltage	I _{IN} = 1 mA I _{IN} = -1 mA	6	6.8 -0.7	8	V V

Table 6. Status pin

Symbol	Parameter	Test conditions		Тур	Max	Unit
V _{STAT}	Status low output voltage	I _{STAT} = 1.6 mA			0.5	V
I _{LSTAT}	Status leakage current	Normal operation; V _{STAT} = 5 V			10	μΑ
C _{STAT}	Status pin input capacitance	Normal operation; V _{STAT} = 5 V			100	pF
V _{SCL}	Status clamp voltage	I _{STAT} = 1 mA; I _{STAT} =-1 mA	6	6.8 -0.7	8	V V

Table 7. Protections

Symbol	Parameter	Test conditions	Min	Тур	Max	Unit
T _{TSD}	Shut-down temperature		150	175	200	°C
T _R	Reset temperature		135			°C
T _{hyst}	Thermal hysteresis		7	20		°C
I _{lim}	Current limitation	$V_{CC} = 24 \text{ V}, R_{LOAD} = 10 \text{ m}\Omega,$ t = 0.4 ms	2.7		6.0	Α
V _{demag}	Turn-off output clamp voltage	$R_L = 12 \Omega$; $L = 6 \text{ mH}$	V _{CC} - 47	V _{CC} - 52	V _{CC} - 57	V

4 Waveforms and truth table

Figure 4. Switching time waveforms

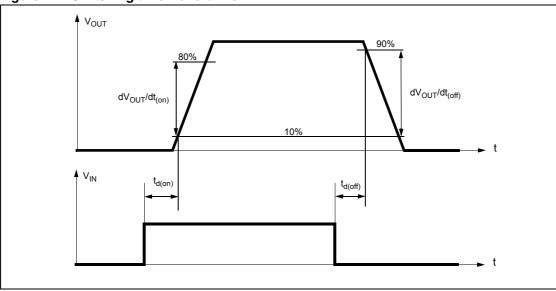
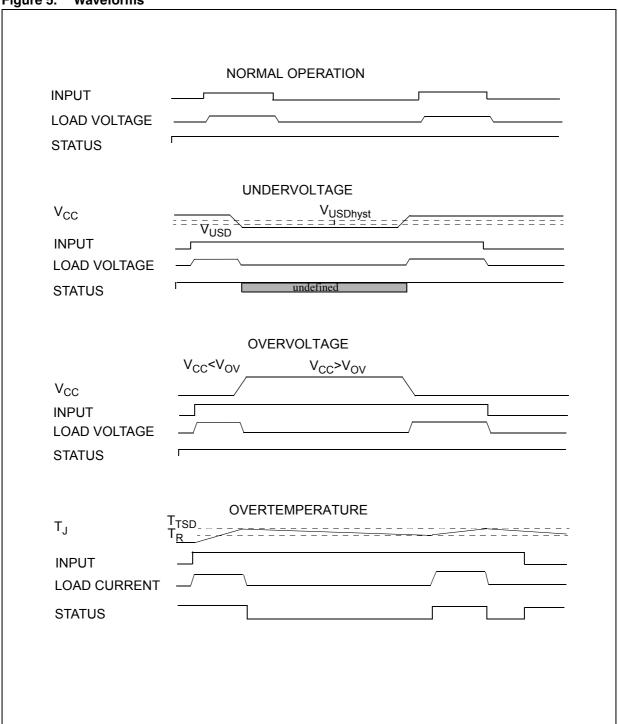


Table 8. Truth table

Conditions	Input	Output	Status
Normal operation	L	L	Н
Normal operation	Н	Н	Н
	L	L	Н
Current limitation	Н	X	$(T_J < T_{TSD}) H$ $(T_J > T_{TSD}) L$
	Н	X	$(T_J > T_{TSD}) L$
Overtemperature	L	L	Н
Overtemperature	Н	L	L
Lindaryoltaga	L	L	X
Undervoltage	Н	L	Х
Overveltage	L	L	Н
Overvoltage	Н	L	Н

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VN751S Test circuit

5 Test circuit

Figure 6. Peak short circuit current test circuit

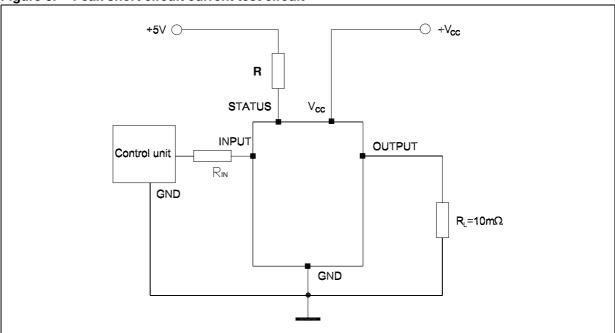
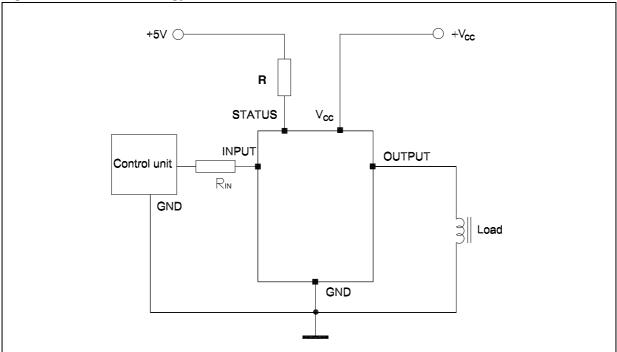
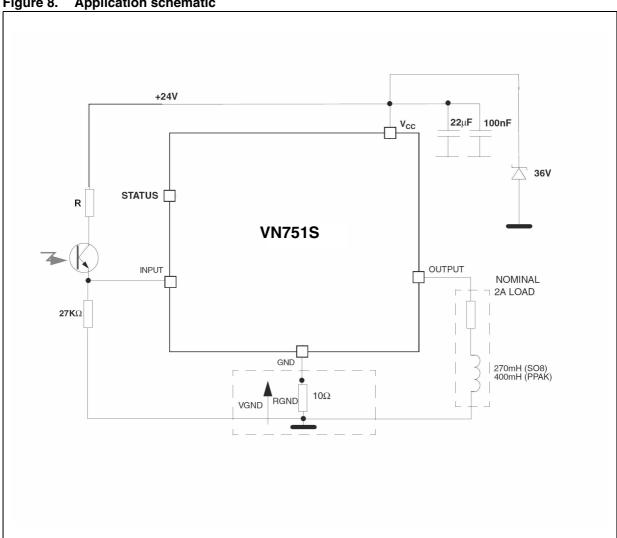


Figure 7. Avalanche energy test circuit



6 **Application schematic**

Figure 8. Application schematic



7 Reverse polarity protection

A schematic solution to protect the IC against a reverse polarity condition is proposed.

This schematic is effective with any type of load connected to the outputs of the IC.

The RGND resistor value can be selected according to the following conditions to be met:

- 1. $R_{GND} \le 600 \text{ mV} / (I_S \text{ in ON state max}).$
- 2. $R_{GND} \ge (-V_{CC}) / (-I_{GND})$

where -IGND is the DC reverse ground pin current and can be found in the absolute maximum rating section of the device datasheet.

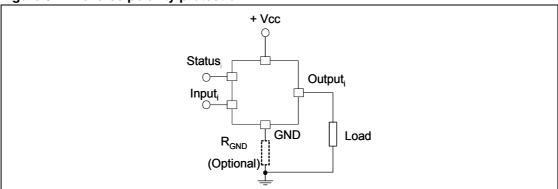
The power dissipation associated to R_{GNG} during reverse polarity condition is:

$$PD = (-V_{CC})^2 / R_{GND}$$

This resistor can be shared by several different ICs. In such case I_S value on formula (1) is the sum of the maximum ON-state currents of the different devices.

Please note that if the microprocessor ground and the device ground are separated then the voltage drop across the R_{GND} (given by I_S in ON state max * R_{GND}) produce a difference between the generated input level and the IC input signal level. This voltage drop will vary depending on how many devices are ON in the case of several high side switches sharing the same R_{GND} .

Figure 9. Reverse polarity protection



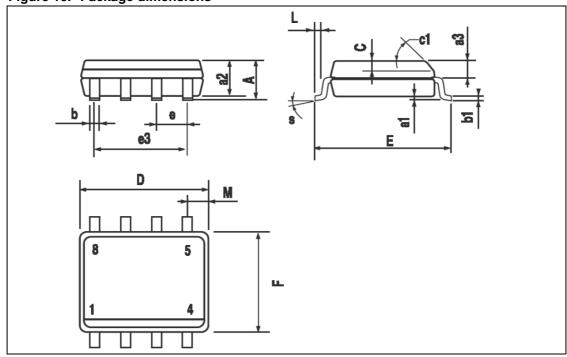
8 Package mechanical data

In order to meet environmental requirements, ST offers these devices in ECOPACK® packages. These packages have a lead-free second level interconnect . The category of second level interconnect is marked on the package and on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an ST trademark. ECOPACK specifications are available at: www.st.com

Table 9. SO-8 mechanical data

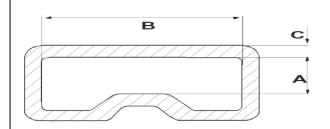
Dim	mm				inch	
Dim.	Min	Тур	Max	Min	Тур	Max
Α			1.75			0.068
a1	0.1		0.25	0.003		0.009
a2			1.65			0.064
a3	0.65		0.85	0.025		0.033
b	0.35		0.48	0.013		0.018
b1	0.19		0.25	0.007		0.010
С	0.25		0.5	0.010		0.019
c1			45 (typ.)		
D	4.8		5.0	0.188		0.196
Е	5.8		6.2	0.228		0.244
е		1.27			0.050	
e3		3.81			0.150	
F	3.8		4.0	0.14		0.157
L	0.4		1.27	0.015		0.050
М			0.6			0.023
S			8º (ı	max.)		

Figure 10. Package dimensions

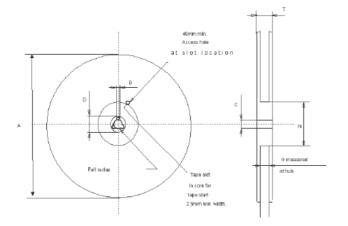


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Figure 11. SO-8 tape and reel information



Base Q.ty	100
Bulk Q.ty	2000
Tube Length(± 0.5)	532
Α	3.2
В	6
C(± 0.1)	0.6



Reel Dimension

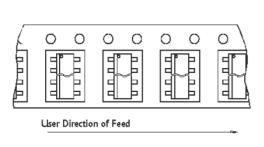
Base Q.ty	2500
Bulk Q.ty	2500
A(Max)	330
B(Min)	1.5
C(± 0.2)	13
F	20.2
G(+2/-0)	12.4
N(Min)	60
T(Max)	18.4

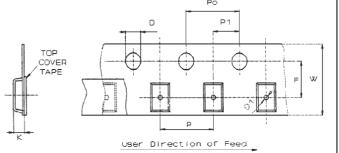
Tape Dimension

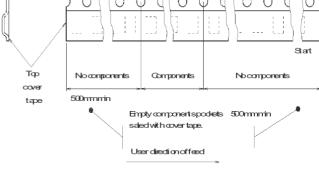
According to Electronic Industries Association(EIA) Standard 481 rev. A, Feb 1986

Tape Width	W	12		
Tape Hole Spacing	P0 (± 0.1)	4		
Component Spacing	Р	8		
Hole Diameter	D(± 0.2/-0)	1.5		
Hole Diameter	D1(Min)	1.5		
Hole Position	F(± 0.05)	5.5		
Compartament Depth	K(Max)	4.5		
Hole Spacing	P1(± 0.1)	2		
All discounting to the second				

All dimension are in mm.







End

VN751S Order code

9 Order code

Table 10. Order codes

Order codes	Package	Packaging
VN751S	SO-8	Tube
VN751STR	SO-8	tape and reel

10 Revision history

Table 11. Document revision history

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Date	Revision	Changes	
18-Sep-2006	1	Initial release	
12-Mar-2007	2	Document reformatted, typo in Section Table 3.: Power on page 5, updated Ptot value Table 2.	
15-May-2007	3	Typo in <i>Table 1 on page 3</i> V _{ESD}	
18-Sep-2007	4	Added I _{STAT} valuein <i>Table 1 on page 3</i>	
11-Oct-2007	5	Updated Table 2 on page 3	
08-Jul-2008	6	Added Section 7 on page 11	

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